

D	RILL CHART: TO	OP to BOTTOM	
AL	L UNITS ARE I	N MILLIMETER	:S
FIGURE	SIZE	PLATED	QTY
•	0.2	PLATED	367
•	0.2	PLATED	34
+	0.9	PLATED	1
A	1.5	NON-PLATED	4

* SURFACE - AIR 0 MM
L1: TOP CONDUCTOR - COPPER 0,035 MM
* DIELECTRIC - FR-4 0.175 MM
L2: L2 CONDUCTOR - COPPER 0.018 MM
DIELECTRIC - FR-4 1,14 MA
L3: L3 CONDUCTOR - COPPER 0.018 MM
DIELECTRIC - FR-4 0.175 MM
L4: BOTTOM CONDUCTOR - COPPER 0.035 MM
* SURFACE - AIR 0 MM

DESIGN CROSS SECTION CHART TOTAL THICKNESS 1.596 MM

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